

### Overview

### HP ZBook Create G7 Notebook PC



#### Top View (Premium keyboard layout)

1. Clickpad
2. Fingerprint sensor (optional)
3. HP Premium backlit Keyboard
4. Layout: ctrl, fn, Windows, alt, space bar, alt, menu, ctrl layout
5. Power-on on lid opening or power button
6. Speakers
7. Camera
8. IR Camera
9. Microphones

### Overview



#### Top View (Z Command keyboard layout; US only)

- |   |                |
|---|----------------|
| 1. Clickpad   | 7. Camera      |
| 2. Fingerprint sensor (optional)                                      | 8. IR Camera   |
| 3. HP Z Command backlit Keyboard                                      | 9. Microphones |
| 4. Layout: fn, Windows, alt, ctrl, space bar, ctrl, alt, menu, layout |                |
| 5. Power-on on lid opening or power button                            |                |
| 6. Speakers   |                |

### Overview



#### Left

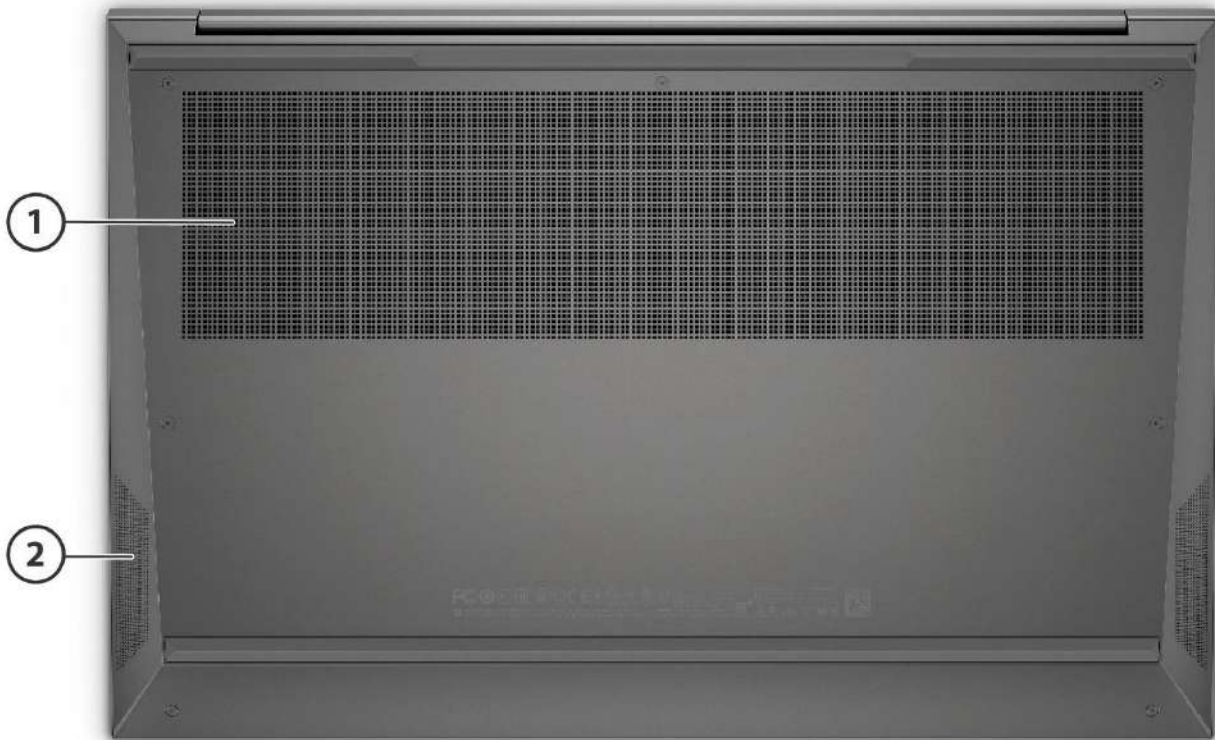
1. Nano security lock slot
2. (1) USB 3.1 Gen 1 Type A charging port
3. Side Vent
4. Headphone/microphone combo jack



#### Right

1. Battery Charging LED
2. 4.5mm AC Power connector
3. (2) USB Type-C® with Thunderbolt™
4. mini DisplayPort™ 1.4 (mini DisplayPort cable is not included)
5. SD 4.0 Card Reader (SD Media not included)

### Overview



### Bottom

1. Fan Venting
2. Speakers

### Overview

#### At A Glance

- Work anywhere without compromising on performance or security with Windows 10 Pro<sup>1</sup>, powered by HP's collaboration and connectivity technology.
- Experience high-end visualization and seamlessly render your biggest projects with the next generation NVIDIA® GeForce® RTX graphics<sup>2</sup>. Plus, the all-new NVIDIA® Turing™ architecture with breakthrough ray tracing technology brings the future of gaming with incredible realism and performance.
- Take multitasking to the next level with up to the 10th gen Intel® Core™ i9 processor<sup>3,4</sup> designed to handle complex, multithreaded apps like Adobe Premiere Pro®, and with fast clock speeds you can boost your speed on single threaded apps like Autodesk 3ds Max.<sup>5</sup>
- Power through projects with up to 32 GB SDRAM<sup>6</sup> for fast rendering, editing and simulating.
- Blitz through multiple tasks and ditch external drives with up to 2 TB local NVMe storage<sup>7</sup>
- Tirelessly re-engineered from the ground up, this is superior design. Vapor chamber<sup>22</sup> cooling and liquid-crystal polymer thermals equip you to run at max performance. Our astonishingly quiet, comfortable keyboard keeps you in the zone. Check out the [HP ZBOOK CREATE AND ZBOOK STUDIO INNOVATIONS WHITEPAPER](#) on the grounds up innovations.
- 4 Speakers (2 tweeters and 2 woofers) custom tuned by Bang and Olufsen surround you in a rich sound space so you hear music the way the audio engineers intended. Featuring the most powerful speakers with the greatest levels of bass on any HP notebook.
- Connect to everything you need with a wide-range of connectivity options: Dual USB-C® Thunderbolt™, mini DisplayPort™ 1.4<sup>11</sup>, USB 3.1 Type A charging port, headphone/microphone combo jack, and AC port.
- Choice of displays<sup>2</sup>:
  - 39.6 cm (15.6") diagonal 4K UHD (3840 x 2160) IPS eDP + PSR anti-glare, 100% DCI-P3, 600 nits VESA Display Next Gen HP DreamColor Panel;
  - 39.6 cm (15.6") diagonal FHD (1920 x 1080) IPS eDP + PSR anti-glare, 100% sRGB at 400 nits low power (1W) panel;
  - 39.6 cm (15.6") diagonal FHD (1920 x 1080) IPS eDP + PSR anti-glare, 72% NTSC at 1000 nits HP Sure View Reflect Integrated Privacy Panel;
  - 39.6 cm (15.6") diagonal 4K UHD (3840 x 2160) UWVA eDP + PSR Brightview 100% DCI-P3, 400 nits OLED VESA Display HDR 500 Certified panel with Corning® Gorilla® Glass 6 Touch Screen
- A completely revamped standby system means you're ready to work the moment inspiration strikes. With no sleep mode and no off mode, the modern standby keeps your rig connected and on demand whenever you need it.
- Transfer files over Wi-Fi® up to 3x faster with Wi-Fi 6<sup>12</sup>
- Have confidence with the HP's most secure mobile workstations<sup>13</sup>. Instantly protect against visual hacking with HP Sure View Reflect<sup>14</sup>, and defend against firmware and malware attacks with HP Sure Start Gen6<sup>10,15</sup> and HP Sure Sense.<sup>9,16</sup>
- A highly recyclable & lightweight aluminum exterior with 5x the abrasion resistance of painted carbon fiber allows for a more durable, thin, and recyclable device.<sup>21</sup>
- HP ZBook Create G7 is designed to undergo extensive MIL-STD 810H testing, and has passed 21 of the MIL-STD 810H tests.<sup>17</sup>
- Plug in to greater connectivity at your desktop with the HP Thunderbolt Dock for lightning-fast Thunderbolt™ 3<sup>18</sup> transfers and the flexibility to run up to two external 4K displays.<sup>19,20</sup>

<sup>1</sup>Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>.

<sup>2</sup>Sold separately or as an optional feature. NVIDIA®, the NVIDIA® logo, NVIDIA Turing™ and NVIDIA® GeForce® are trademarks and/or registered trademarks of NVIDIA Corporation in the U.S. and other countries

<sup>3</sup>Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

<sup>4</sup>Intel® Turbo Boost technology requires a PC with a processor with Intel Turbo Boost capability. Intel Turbo Boost performance varies depending on hardware, software and overall system configuration. See [www.intel.com/technology/turboboost](http://www.intel.com/technology/turboboost) for more information. "

<sup>5</sup>Adobe and Autodesk software sold separately.

### Overview

<sup>6</sup>Up to 32GB memory is an optional, configurable feature.

<sup>7</sup>For hard drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB (for Windows 10) of system disk is reserved for system recovery software.

<sup>9</sup> HP Sure Sense requires Windows 10 Pro or Enterprise. See product specifications for availability.

<sup>10</sup>HP Sure Start Gen6 is available on select HP PCs.

<sup>11</sup>miniDisplayPort cables are sold separately.

<sup>12</sup>Wi-Fi 6 offers up to 3x faster file transfer speeds than Wi-Fi® 5 Based on Wi-Fi 5 80MHz and Wi-Fi 6 160MHz minimum requirements when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 802.11ax (Wi-Fi 6). Only available in countries where 802.11ax is supported

<sup>13</sup>Based on HP's unique and comprehensive security capabilities at no additional cost among desktop workstation vendors as of Sept. 2017 on HP Mobile Workstations with 7th Gen and higher Intel® Processors.

<sup>14</sup>HP Sure View integrated privacy screen is an optional feature that must be configured at purchase.

<sup>15</sup>HP Sure Start Gen5 is available on select HP PCs with Intel processors. See product specifications for availability. Some Sure Start features are limited to Windows Operating System. HP Sure Start end user notifications and HP Sure Start event logging support is limited to Windows Operating system. These features are not supported in Linux.

<sup>16</sup> HP Sure Sense requires Windows 10 Pro or Enterprise. See product specifications for availability.

<sup>17</sup>Testing is not intended to demonstrate fitness of U.S. Department of Defense (DoD) contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

<sup>18</sup>HP Thunderbolt Dock with Thunderbolt™ 3 sold separately.

<sup>19</sup>External displays sold separately.

<sup>20</sup>Optional hybrid graphics is required to run up to two external 4K displays.

<sup>21</sup>HP Internal Testing conducted on July 2018, using ASTM International Standards Worldwide using test method ASTM D4060

<sup>22</sup> The HP Z VaporForce (vapor chamber) is only available on configurations with NVIDIA® Quadro® RTX Graphics.

**NOTE: See important legal disclosures for all listed specs in their respective feature's sections.**

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### Features

#### OPERATING SYSTEM

<b>Preinstalled OS</b>	Windows 10 Pro 64 - HP recommends Windows 10 Pro for business. <sup>1</sup> Windows 10 Home 64 <sup>1</sup> Windows 10 Pro for Workstations 64 <sup>1</sup> Ubuntu 20.04 <sup>2</sup> FreeDOS 3.0
<b>Supported OS<sup>4</sup></b>	Windows 10 64 Enterprise

<sup>1</sup> Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>.

<sup>3</sup> Ubuntu 20.04 to be available in the 2<sup>nd</sup> half of 2020

<sup>4</sup>Support to be tested and documented or web support only.

#### PROCESSOR

10<sup>th</sup> Generation Intel® Core™ i9 10885H with Intel® UHD Graphics (2.4 GHz base frequency, up to 5.3 GHz with Intel® Turbo Boost Technology, 16 MB L3 cache, 8 cores) supporting Intel® vPro® technology<sup>1,2,3,4,5</sup>

10<sup>th</sup> Generation Intel® Core™ i7 10850H with Intel® UHD Graphics (2.7 GHz base frequency, up to 5.1 GHz with Intel® Turbo Boost Technology, 12 MB L3 cache, 6 cores) supporting Intel® vPro® technology<sup>1,2,3,4,5</sup>

10<sup>th</sup> Generation Intel® Core™ i7 10750H with Intel® UHD Graphics (2.6 GHz base frequency, up to 5.0 GHz with Intel® Turbo Boost Technology, 12 MB L3 cache, 6 cores)<sup>1,2,3,4</sup>

10<sup>th</sup> Generation Intel® Core™ i5 10400H with Intel® UHD Graphics (2.6 GHz base frequency, up to 4.6 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores) supporting Intel® vPro® technology<sup>1,2,3,4,5</sup>

<sup>1</sup> Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

<sup>2</sup> Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

<sup>3</sup> Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. Energy Efficient Turbo is a power management feature that can lower the maximum core ratio (frequency), if the CPU thinks it can achieve about the same performance as with the maximum turbo frequency. Energy Efficient Turbo feature is disabled in Comet Lake H in order to prioritize performance in DC mode. It can be changed in F10 BIOS settings. See [www.intel.com/technology/turboboost](http://www.intel.com/technology/turboboost) for more information.

<sup>4</sup> In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <http://www.support.hp.com>.

<sup>5</sup> For full Intel® vPro® functionality, Windows, a vPro supported processor, vPro enabled Q370 chipset or higher and vPro enabled WLAN card are required. Some functionality, such as Intel Active management technology and Intel Virtualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances" applications for Intel vPro technology is dependent on 3rd party software providers. Compatibility of this generation of Intel vPro technology-based hardware with future "virtual appliances" is yet to be determined.

### Features

#### CHIPSET

Intel® WM490 Chipset

#### INTEL® CORE™ I5 WITH VPRO/CORE™ I7 WITH VPRO TECHNOLOGY CAPABLE

Intel® Core™ i5 with vPro®, Core™ i7 with vPro®, and Core™ i9 with vPro® technology is a selectable feature that is available on units configured with select processors, a qualified Intel® select WLAN module and a preinstalled Windows 10 Pro 64 and above. It provides advances in remote manageability, security, energy efficient performance, and wireless connectivity. Intel® Active Management Technology (iAMT) offers built-in manageability and proactive security for networked mobile workstations, even when they are powered off\* or when the operating system is inoperable. It can help identify threats before they reach the network, isolate infected systems, and update regardless of their power state.<sup>1,2</sup>

<sup>1</sup> Requires a Windows operating system, network hardware and software, connection with a power source, and a direct (non-VPN) corporate network connection which is either cable or wireless LAN.

<sup>2</sup> Some functionality of Intel® Core™ i5 with vPro®/Core™ i7 with vPro®/Core™ i9 with vPro® technology, such as Intel® Active Management technology and Intel® Virtualization technology, requires additional third-party software in order to run. Availability of future "virtual appliances" applications for Intel® Core™ i5 with vPro®/Core™ i7 with vPro® technology is dependent on third-party software providers. Compatibility with future "virtual appliances" is yet to be determined.

<sup>2</sup> Intel® Active Management Technology (iAMT) built-in manageability only available with Intel vPro processor + Intel vPro WLAN module

#### GRAPHICS

##### Integrated for Hybrid graphics model

Intel® UHD Graphics <sup>1, 2, 3, 4, 5, 6</sup>

##### Discrete

NVIDIA GeForce RTX 2070 with Max-Q Design (8 GB GDDR6 dedicated)<sup>2, 6, 8</sup>

NVIDIA GeForce RTX 2070 Super with Max-Q Design (8 GB GDDR6 dedicated)<sup>2, 6, 8</sup>

NVIDIA GeForce RTX 2080 Super with Max-Q Design (8 GB GDDR6 dedicated)<sup>2, 6, 8</sup>

Supports up to 4 displays through discrete graphics and dock

Supports: NVIDIA Surround Technology for NVIDIA GeForce Graphics

Max resolution for external displays: HDMI 1.4 4096x2304 @30Hz; DisplayPort via USB-C® Thunderbolt™ 4096x2304 @60Hz

<sup>1</sup> UHD content required to view UHD images.

<sup>2</sup> Both UMA & Discrete configurations support 4 independent displays when on the HP Thunderbolt Dock G2 (sold separately) - Max. resolution = 2.5K @60Hz (DP1) & 2.5K @60Hz (DP2) & FHD (VGA) OR 4K @60Hz (one DP Port) & 4K @60Hz (Type-C® output port using a Type C®-to-DP adapter).

<sup>3</sup> Support HD decode, DX11, DX12, HDMI 1.4, HDCP 2.3 via DP up to 4K @ 60Hz and via HDMI up to 4K @ 30Hz

<sup>4</sup> miniDisplayPort™ cable Sold Separately

<sup>5</sup> Shared video memory (UMA) uses part of the total system memory for video performance. System memory dedicated to video performance is not available for other use by other programs.

<sup>6</sup> GPU configurations may be limited to specific GPU/Memory Configurations.

<sup>8</sup> miniDP cable sold separately.



### Features

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#### DISPLAY

##### Non-touch

- 39.6 cm (15.6") diagonal 4K UHD (3840 x 2160) IPS eDP + PSR anti-glare, 100% DCI-P3, 600 nits VESA Display Next Gen HP DreamColor Panel<sup>2,3,5,6</sup>
- 39.6 cm (15.6") diagonal FHD (1920 x 1080) IPS eDP + PSR anti-glare, 100% sRGB at 400 nits (1W) low power panel<sup>2,3,5,6</sup>
- 39.6 cm (15.6") diagonal FHD (1920 x 1080) IPS eDP + PSR anti-glare, 72% NTSC at 1000 nits HP Sure View Reflect Integrated Privacy Panel<sup>2,3,5,6</sup>

##### Touch

- 39.6 cm (15.6") diagonal 4K UHD (3840 x 2160) UWVA eDP + PSR Brightview 100% DCI-P3, 400 nits OLED VESA Display HDR 500 Certified panel with Corning® Gorilla® Glass 6 Touch Screen<sup>2,3,5,6</sup>

##### HP Virtual Reality<sup>7</sup> Headset (sold separately)

- HP Reverb
- HP Reverb G2

<sup>1</sup> HP Sure View Reflect is optional and must be configured at purchase.

<sup>2</sup> UHD content required to view UHD images.

<sup>3</sup> Resolutions are dependent upon monitor capability, and resolution and color depth settings.

<sup>5</sup> Display options may be limited to specific CPU / GPU Configurations.

<sup>6</sup> VESA Display HDR 500 certification is pending.

<sup>7</sup> Virtual Reality content is required to view Virtual Reality images

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### Features

#### STORAGE AND DRIVES\*

##### 1 M.2 Storage (PCIe NVMe™ SSD) slot<sup>1</sup>

256 GB PCIe® Gen3 x4 NVMe™ M.2 2280 TLC Solid State Drive (SSD)

512 GB PCIe® Gen3 x4 NVMe™ M.2 2280 TLC Solid State Drive (SSD)

1 TB PCIe® Gen3 x4 NVMe™ M.2 2280 TLC Solid State Drive (SSD)

2 TB PCIe® Gen3 x4 NVMe™ M.2 2280 TLC SSD

512 GB PCIe® Gen3 x4 NVMe™ M.2 2280 TLC Self Encrypting (SED) Solid State Drive (SSD)

<sup>1</sup>M.2 Storage Slot does not support SATA drives

\* For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35GB of disk is reserved for system recovery software.

#### DRIVE CONTROLLERS

M.2 Storage Bay (PCIe NVMe)

PCIe® Gen3 x4 NVMe™ Solid State Drive

SATA

Not supported

RAID

Not supported

#### MEMORY

##### Maximum Memory

32 GB DDR4 non-ECC SDRAM<sup>1,2</sup>

Memory soldered down. Supports Dual Channel Memory<sup>3</sup>

System Runs at: 2933

<sup>1</sup>Memory is soldered down and not upgradeable

<sup>2</sup>Memory configurations may be limited to specific CPU / GPU Configurations.

<sup>3</sup>Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

### Features

#### NETWORKING/COMMUNICATIONS

##### WLAN

Intel® Wi-Fi 6 AX201 (2x2) and Bluetooth® 5 combo, vPro® 1,2,3

Intel® Wi-Fi 6 AX201 (2x2) and Bluetooth® 5 combo, non-vPro® 1

<sup>1</sup>Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. The specifications for Wi-Fi 6 (802.11ax WLAN) are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax WLAN devices. Only available in countries where 802.11ax is supported.

<sup>2</sup>Some functionality of vPro®, such as Intel Active management technology and Intel Virtualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances" applications for Intel vPro® technology is dependent on 3rd party software providers. Compatibility with future "virtual appliances" is yet to be determined.

<sup>3</sup>Intel® Active Management Technology (iAMT) built-in manageability only available with Intel vPro processor + Intel vPro WLAN module

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#### AUDIO/MULTIMEDIA

##### Audio

Audio by Bang & Olufsen, quad speakers (2 tweeters and 2 woofers), HP World Facing Microphone dual array digital microphone, functions keys for volume up and down, combo microphone/headphone jack, HD audio with 150Hz Bass Roll off

##### Camera<sup>1,2</sup>

720p HD with Temporal Noise Reduction webcam with IR

<sup>1</sup> HD content required to view HD images.

<sup>2</sup> Windows Hello face authentication utilizes a camera specially configured for near infrared (IR) imaging to authenticate and unlock Windows devices as well as unlock your Microsoft Passport.

### Features

#### KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

##### Keyboard

HP Premium Quiet Keyboard, full-size, spill-resistant, backlit, with drain and DuraKeys, clickpad with image sensor and glass surface, multi-touch gestures and taps enabled

HP Premium Quiet Z Command Keyboard<sup>1</sup>, full-size, spill-resistant, backlit, with drain and DuraKeys, clickpad with image sensor and glass surface, multi-touch gestures and taps enabled

##### Pointing Devices

Clickpad with multi-touch gestures enabled, taps enabled as default

Microsoft Precision Touchpad Default Gestures Support

##### Buttons and Function Keys

Discrete buttons provide easy access to the following features:

F1 – Display Switching

F2 – HP Sure View on/off (if configured)

F3 – Brightness Down

F4 – Brightness Up

F5 – Audio mute

F6 – Volume down

F7 – Volume up

F8 – Microphone mute

F9 – Keyboard backlight

F10 – Insert

F11 – Airplane Mode on/off

F12 – Programmable Key

Print Screen

Power Button on/off

Delete

Fn key lock

Hidden Function Keys:

Fn+R=Break

Fn+S=Sys Rq

Fn+C=Scroll Lock

Fn+W=Pause

<sup>1</sup>Only available in the US, and optional

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#### SOFTWARE AND SECURITY

##### Workstation ISV Certifications

See the latest list of certifications at: <http://www.hp.com/go/isv>

##### HP ZCENTRAL REMOTE BOOST SOFTWARE

The remote desktop solution for serious workstation users and their most demanding applications. Download at:

<http://www.hp.com/go/RGS>

##### HP Performance Advisor

HP Performance Advisor enables optimal configuration of HP Mobile Workstations delivering stability and best performance.

HP Performance Advisor will guide your system setup allowing a "custom" configuration that best matches the workstation

to user requirements. Download at: <http://www.hp.com/go/performanceadvisor>

##### Software

Bing search for IE11

### Features

Buy Office  
HP Hotkey Support  
HP Noise Cancellation Software  
HP Performance Advisor<sup>8</sup>  
HP Z Central Remote Boost Software<sup>2</sup>  
Native Miracast support<sup>4</sup>  
HP Connection Optimizer<sup>9</sup>  
HP Smart Support<sup>19</sup>

#### **Security Management**

Absolute persistence module<sup>6</sup>  
HP Device Access Manager  
HP FingerPrint Sensor  
HP Manageability Integration Kit<sup>11</sup>  
HP Power On Authentication  
HP Support Assistant  
Security lock slot<sup>12</sup>  
Trusted Platform Module TPM 2.0 Embedded Security Chip  
Master Boot Record security  
Pre-boot authentication  
Microsoft Security Defender<sup>10</sup>  
HP Client Security Manager<sup>17</sup>  
HP BIOSphere Gen6<sup>5</sup>  
HP Sure Recover Gen3<sup>13</sup>  
HP Sure Start Gen6<sup>5, 15</sup>  
HP Secure Erase<sup>16</sup>  
HP Sure Sense<sup>18</sup>  
HP Sure Click 1.5  
HP Image Assistant Gen4.6  
HP Smart Support<sup>19</sup>

#### **BIOS Version**

ISO/IEC 19678: 2015 (formerly NIST 800-147) compliant  
UEFI version: 2.7

#### **TPM**

Model: Infineon SLB9670  
Version: 7.63.3353.0  
Revision: TPM 2.0  
FIPS 140-2 Compliant: Yes with Convert TPM to 2.0 (FIPS 140-2) option

#### **Fingerprint Sensor (Optional)**

Voltage: 3.0-3.6V  
Operating temperature: -20° - 85°C  
Imaging current: 31mA  
Wake on finger current: 40 uA  
Capture rate: 30ms/frame  
ESD Resistance: IEC 6100-4-2 4B (+/-15KV)  
Detection Matrix: 363 dpi, sensing area 8x8 mm

#### **Security Features**

HP Fingerprint Sensor (optional)<sup>19</sup>  
IR Camera with Windows Hello

**For more information on HP Client Security Software Suite, refer to <http://www.hp.com/go/clientsecurity>.**

### Features

- <sup>2</sup> HP Z Central Remote Boost Software does not come preinstalled on Z Workstations but can be downloaded and run on all Z desktop and laptops without license purchase. With non-Z sender devices, purchase of perpetual individual license or perpetual floating license per simultaneously executing versions and purchase of ZCentral Remote Boost Software Support is required. RGS requires Windows, RHEL (7 or 8), UBUNTU 18.04 LTS, or HP ThinPro 7 operating systems. MacOS (10.13 or newer) operating system is only supported on the receiver side. Requires network access. The software is available for download at [hp.com/ZCentralRemoteBoost](http://hp.com/ZCentralRemoteBoost).
- <sup>4</sup> Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: <http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast>.
- <sup>5</sup> HP BIOSphere Gen6 is available on select HP Pro, Elite and ZBook PCs. See product specifications for details. Features may vary depending on the platform and configurations.
- <sup>6</sup> Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: <http://www.absolute.com/company/legal/agreements/computrace-agreement>. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.
- <sup>8</sup> HP Performance Advisor Software - HP Performance Advisor is ready and waiting to help you get the most out of your HP Workstation from day one—and every day after. Learn more or download at: <https://www8.hp.com/us/en/workstations/performance-advisor.html>
- <sup>9</sup> HP Connection Optimizer requires Windows 10.
- <sup>10</sup> Microsoft Defender Opt in and internet connection required for updates.
- <sup>11</sup> HP Manageability Integration Kit can be downloaded from <http://www.hp.com/go/clientmanagement>.
- <sup>12</sup> Nano Security lock slot is Lock sold separately.
- <sup>13</sup> HP Sure Recover Gen3: See product specifications for availability. Requires an open, wired network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. HP Sure Recover (Gen1) does not support platforms with Intel® Optane™.
- <sup>15</sup> HP Sure Start Gen6 is available on select HP PCs with Intel processors. See product specifications for availability. Some Sure Start features are limited to Windows Operating System. HP Sure Start end user notifications and HP Sure Start event logging support is limited to Windows Operating system. These features are not supported in Linux.
- <sup>16</sup> For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.
- <sup>17</sup> HP Client Security Manager Gen5 requires Windows and is available on select HP Pro, Elite and ZBook PCs. See product specifications for details.
- <sup>18</sup> HP Sure Sense requires Windows 10 Pro or Enterprise. See product specifications for availability.
- <sup>19</sup> HP Smart Support is available to commercial customers through your HP Service Representative and HP Factory Configuration Services; or it can be downloaded at: <http://www.hp.com/smart-support>. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights.

### Features

#### **POWER**

##### **Power Supply**

Up to 14 hours<sup>1</sup>

HP Long Life 6-cell, 83 Wh Li-ion polymer<sup>2</sup>

Supports battery HP Fast Charge: approximately 50% in 30 minutes

HP Smart 200 W External AC Power Adapter

<sup>1</sup> Battery life will vary depending on the product model, configuration, loaded applications, features, use, wireless functionality and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See MobileMark14 battery benchmark <https://bapco.com/products/mobilemark-2014/> for additional details.

<sup>2</sup> Supports HP Fast Charge Technology (50% of the charge in 30 minutes)

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#### **ENVIRONMENTAL**

ENERGY STAR® certified and EPEAT® GOLD registered configurations available<sup>1</sup>

Low halogen<sup>2</sup>

<sup>1</sup> Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit [www.epeat.net](http://www.epeat.net) for more information.

<sup>2</sup> External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.

### Features

#### WEIGHTS & DIMENSIONS

**Dimensions (w x d x h)**

35.4 x 23.46 x 1.79 cm (non-touch)

13.93 x 9.24 x 0.70 in (non-touch)

35.4 x 23.46 x 1.75 cm (touch)

13.93 x 9.24 x 0.69 in (touch)

**Max. hinge open angle on:** 150°

**Weights**

Starting at 1.92kg (4.23 lb)

Weight varies by configuration and components.

A deck: Anodized Aluminium with plastic bumper

B deck: Anodized Aluminium for Non-Touch sku; Touch has Corning® Gorilla® Glass 5

C deck: Anodized Aluminium

D deck: Magnesium Die Cast

Metal Alloy Hinges

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#### PORTS/SLOTS

**Right side**

1 4.5mm AC power connector

2 Thunderbolt™ 3 (40Gbps signaling rate) with SuperSpeed USB Type-C® 10Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.2, HP Sleep and Charge) [USB Type-C® with Thunderbolt™ 3]

1 mini DisplayPort™ 1.4 connector

1 SD 4.0 Media Reader<sup>1,2</sup>

**Left side**

1 SuperSpeed USB Type-A 5Gbps signaling rate (charging) [USB 3.1 Gen 1 Type A charging]

1 headphone/microphone combo

<sup>1</sup> SD Media does not come with the device and requires compatible media in order to use the slot.

<sup>2</sup> SD 4.0 supports next generation secure digital and is compatible to SD, SDHC, SDXC media

#### SERVICE AND SUPPORT

3-year limited warranty options available, depending on country. Batteries have a default one-year limited warranty except for Long Life Batteries which will have same 1-year or 3-year limited warranty as the platform. Optional<sup>1</sup> HP Care Pack Services are extended service contracts which go beyond your standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at <http://www.hp.com/go/cpc>.

<sup>1</sup>Sold separately or as an optional feature. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product. Consult your local HP Customer Support Center for details.



### Technical Specifications – System Unit

#### SYSTEM UNIT

<b>Stand-Alone Power Requirements (AC Power)</b> UHD panel : 600nits	<b>Nominal Operating Voltage</b>	19.5 V		
	<b>Average Operating Power(MM14)</b> <b>Average Operating Power(idle)</b>	4.38W 495mW (MSC) , 2.693W (Idle)	<b>System in idle mode + max panel brightness</b>	<b>Adapter Safety test condition</b>
			FHD panel : 400nits UHD panel : 600nits	
	<b>Integrated graphics</b>	45W<CPU (Intel did not define TDP for iGPU)		
	<b>Discrete Graphics</b>	35W		
	<b>Max Operating Power</b>	Discrete < 105W		
<b>Temperature</b>	<b>Operating</b>	32° to 95° F (0° to 35° C) (Not Writing Optical)		
	<b>Non-operating</b>	-4° to 140° F (-20° to 60° C) (writing optical)		
<b>Relative Humidity</b>	<b>Operating</b>	10% to 90%, non-condensing		
	<b>Non-operating</b>	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature		
<b>Shock</b>	<b>Operating</b>	40 G, 2 ms, half-sine		
	<b>Non-operating</b>	200 G, 2 ms, half-sine		
<b>Random Vibration</b>	<b>Operating</b>	0.75 grms		
<b>Planned Industry Standard Certifications</b>	<b>UL</b>	Yes		
	<b>CSA</b>	Yes		
	<b>FCC Compliance</b>	Yes		
	<b>ENERGY STAR®</b>	Yes		
	<b>EPEAT®</b>	EPEAT® Gold in United States <sup>2</sup>		
	<b>ICES</b>	Yes		
	<b>Australia / NZ A-Tick Compliance</b>	Yes		
	<b>CCC</b>	Yes		
	<b>Japan VCCI Compliance</b>	Yes		
	<b>KCC</b>	Yes		
	<b>BSMI</b>	Yes		
	<b>CE Marking Compliance</b>	Yes		
	<b>MIL STD 810H</b>	Yes, Passed 21 Tests		
	<b>BNCI or BELUS</b>	Yes		
	<b>CIT</b>	Yes		
	<b>Saudi Arabian Compliance (ICCP)</b>	Yes		
<b>SABS</b>	Yes			

<sup>1</sup>Configurations of the HP ZBook Create G7 Notebook PC that are ENERGY STAR® qualified are identified as HP ZBook Create G7 Notebook PC ENERGY STAR on HP websites and on <http://www.energystar.gov>.

<sup>2</sup>EPEAT® registered where applicable. EPEAT registration varies by country. See <http://www.epeat.net> for registration status by country. Search keyword generator on HP's 3rd party option store for solar generator accessories at [www.hp.com/go/options](http://www.hp.com/go/options).

### Technical Specifications – Displays

#### DISPLAYS

<b>15.6" diagonal, 4K UHD (3840 x 2160), IPS, anti-glare, 600 nits, 100% DCI-P3, Next Gen HP DreamColor</b>	<b>Outline Dimensions (W x H)</b>	350.22 x 216.37(mm) max
	<b>Active Area</b>	344.22 x 193.62 (mm)
	<b>Weight</b>	300g max.
	<b>Diagonal Size</b>	15.6 (inch)
	<b>Thickness</b>	2.6 (mm) max
	<b>Interface</b>	eDP1.4
	<b>Surface Treatment</b>	Anti-glare (AG)
	<b>Touch enabled</b>	No
	<b>Contrast Ratio</b>	1700:1 (typical)
	<b>Refresh Rate</b>	60Hz
	<b>Brightness</b>	600 nit typical (Panel Only)
	<b>Pixel Resolution</b>	<b>Pitch</b> 3840 x 2160 (UHD)
	<b>Backlight</b>	RGB
	<b>PPI</b>	LED
	<b>Color Gamut Coverage</b>	DCI-P3 100%
	<b>Delta E</b>	<2
	<b>Color Depth</b>	8 bits + 2 FRC
<b>Viewing Angle</b>	UWVA 85/85/85/85	
<b>15.6" diagonal, FHD (1920 x 1080), IPS, anti-glare, 400 nits, low power, 72% NTSC low power (1W) panel</b>	<b>Outline Dimensions (W x H)</b>	349.46 x 215.9 max.
	<b>Active Area</b>	344.16 x 193.59 typ.
	<b>Weight</b>	310g max
	<b>Diagonal Size</b>	15.6
	<b>Thickness</b>	2.6t max.
	<b>Interface</b>	eDP 1.4
	<b>Surface Treatment</b>	Anti-glare (AG)
	<b>Touch enabled</b>	No
	<b>Contrast Ratio</b>	1200:1 (typ)
	<b>Refresh Rate</b>	60Hz
	<b>Brightness</b>	400nit typ.
	<b>Pixel Resolution</b>	<b>Pitch</b> 1920 x 1080 (FHD)
	<b>Backlight</b>	RGB
	<b>PPI</b>	LED
	<b>Color Gamut Coverage</b>	sRGB 100%
	<b>Color Depth</b>	8bit
	<b>Viewing Angle</b>	UWVA 85/85/85/85
<b>15.6" diagonal, 4K UHD (3840 x 2160), touch, OLED UWVA, BrightView, Corning® Gorilla® Glass</b>	<b>Outline Dimensions (W x H)</b>	348.348x216.202 (mm) max
	<b>Active Area</b>	344.2176 x 193.6224 (mm)
	<b>Weight</b>	200g max.
	<b>Diagonal Size</b>	15.6 (inch)

### Technical Specifications – Displays

<b>6,400 nits, HDR 500, 100% DCI-P3</b>	<b>Thickness</b>	2.195(mm) max	
	<b>Interface</b>	eDP 1.4	
	<b>Surface Treatment</b>	Glare (BV)	
	<b>Touch enabled</b>	Yes	
	<b>Contrast Ratio</b>	100,000:1	
	<b>Refresh Rate</b>	60Hz	
	<b>Brightness</b>	400nit (Panel Only)	
	<b>Pixel Resolution</b>	<b>Pitch</b>	3840 x 2160 (UHD)
	<b>Backlight</b>	RGB	
	<b>PPI</b>	OLED	
	<b>Color Gamut Coverage</b>	DCI P3 100%	
	<b>Color Depth</b>	8 bits + 2 FRC	
	<b>Viewing Angle</b>	UWVA 85/85/85/85	
	<b>15.6" diagonal, FHD (1920 x 1080), IPS, anti-glare, 1000 nits, 72% NTSC, HP Sure View Reflect integrated privacy screen</b>	<b>Outline Dimensions (W x H)</b>	349.52 x 205.39 max.
<b>Active Area</b>		344.16 x 193.59 typ.	
<b>Weight</b>		370g max.	
<b>Diagonal Size</b>		15.6"	
<b>Thickness</b>		2.6mm / 4.5mm max. (PCB)	
<b>Interface</b>		eDP	
<b>Surface Treatment</b>		LCD	
<b>Touch enabled</b>		Anti-glare (AG)	
<b>Contrast Ratio</b>		No	
<b>Refresh Rate</b>		1500:1	
<b>Brightness</b>		60Hz	
<b>Pixel Resolution</b>		<b>Pitch</b>	1920 x 1080 (FHD)
<b>Backlight</b>		LED	
<b>PPI</b>		141	
<b>Color Gamut Coverage</b>	100% sRGB		
<b>Color Depth</b>	8 bits		
<b>Viewing Angle</b>	UWVA 85/85/85/85		

### Technical Specifications – Storage

#### STORAGE AND DRIVES

<b>256 GB PCIe® Gen3 x4 NVMe™ M.2 2280 TLC Solid State Drive (SSD)</b>	<b>Form Factor</b>	M.2 2280	
	<b>Capacity</b>	256 GB	
	<b>NAND Type</b>	TLC	
	<b>Height</b>	0.09 in (2.3 mm)	
	<b>Width</b>	0.87 in (22 mm)	
	<b>Weight</b>	0.02 lb (<10 g)	
	<b>Interface</b>	PCIe® Gen3 x4 NVMe™	
	<b>Performance</b>	<b>Maximum Sequential Read</b>	<b>Maximum Sequential Write</b>
		2580 MB/s ~ 2600 MB/s	1000 MB/s ~ 1100 MB/s
	<b>Logical Blocks</b>	500,118,192	
<b>Operating Temperature</b>	32° to 158°F (0° to 70°C) [ambient temp]		
<b>Features</b>	ATA Security, TRIM; L1.2		
	<b>Note:</b> For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35 GB (for Windows 10) is reserved for system recovery software.		

<b>512 GB PCIe® Gen3 x4 NVMe™ M.2 2280 TLC Self Encrypting (SED) Solid State Drive (SSD)</b>	<b>Form Factor</b>	M.2 2280	
	<b>Capacity</b>	512 GB	
	<b>NAND Type</b>	TLC	
	<b>Height</b>	0.09 in (2.3 mm)	
	<b>Width</b>	0.87 in (22 mm)	
	<b>Weight</b>	0.02 lb (<10 g)	
	<b>Interface</b>	PCIe® Gen3 x4 NVMe™	
	<b>Performance</b>	<b>Maximum Sequential Read</b>	<b>Maximum Sequential Write</b>
		2800 MB/s ~ 2900 MB/s	1000 MB/s ~ 1800 MB/s
	<b>Logical Blocks</b>	1,000,215,215	
<b>Operating Temperature</b>	32° to 158°F (0° to 70°C) [ambient temp]		
<b>Features</b>	ATA Security (Option); TCG Opal 2.0 ; TRIM; L1.2		
	<b>Note:</b> For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35 GB (for Windows 10) is reserved for system recovery software.		

<b>1 TB PCIe® Gen3 x4 NVMe™ M.2 2280 TLC Solid State Drive (SSD)</b>	<b>Form Factor</b>	M.2 2280	
	<b>Capacity</b>	1TB	
	<b>NAND Type</b>	TLC	
	<b>Height</b>	0.09 in (2.3 mm)	
	<b>Width</b>	0.87 in (22 mm)	
	<b>Weight</b>	0.02 lb (<10 g)	
	<b>Interface</b>	PCIe® Gen3 x4 NVMe™	
	<b>Performance</b>	<b>Maximum Sequential Read</b>	<b>Maximum Sequential Write</b>
		2900 MB/s ~ 3000 MB/s	Up to 2000 MB/s
	<b>Logical Blocks</b>	2,000,409,264	
<b>Operating Temperature</b>	32° to 158°F (0° to 70°C) [ambient temp]		

### Technical Specifications – Storage

	<b>Features</b>	ATA Security, TRIM; L1.2 <b>Note:</b> For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35 GB (for Windows 10) is reserved for system recovery software.		
<b>2 TB PCIe® Gen3 x4 NVMe™ M.2 2280 TLC Solid State Drive (SSD)</b>	<b>Form Factor</b>	M.2 2280		
	<b>Capacity</b>	2 TB		
	<b>NAND Type</b>	TLC		
	<b>Height</b>	0.09 in (2.3 mm)		
	<b>Width</b>	0.87 in (22 mm)		
	<b>Weight</b>	0.02 lb (<10 g)		
	<b>Interface</b>	PCIe® Gen3 x4 NVMe™		
	<b>Performance</b>	<b>Maximum Sequential Read</b>	<b>Maximum Sequential Write</b>	
		Up to 2900MB/s	Up to 2100 MB/s	
	<b>Logical Blocks</b>	3,907,029,168		
<b>Operating Temperature</b>	32° to 158°F (0° to 70°C) [ambient temp]			
	<b>Features</b>	ATA Security, TRIM; L1.2 <b>Note:</b> For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35 GB (for Windows 10) is reserved for system recovery software.		

### Technical Specifications – Networking

#### NETWORKING/COMMUNICATION

<p><b>Intel® Wi-Fi 64 AX201 and Bluetooth® 5.0 802.11ax (2 x 2) (Supporting gigabit file transfer speeds) vPro®</b></p>	<p><b>Wireless LAN Standards</b></p>	<p>IEEE 802.11a          IEEE 802.11b          IEEE 802.11g          IEEE 802.11n          IEEE 802.11ac          IEEE 802.11ax          IEEE 802.11d          IEEE 802.11e          IEEE 802.11h          IEEE 802.11i          IEEE 802.11k          IEEE 802.11r          IEEE 802.11v</p>
	<p><b>Interoperability</b></p>	<p>Wi-Fi certified</p>
	<p><b>Frequency Band</b></p>	<p>802.11b/g/n/ax          • 2.402 – 2.482 GHz          802.11a/n/ac/ax          • 4.9 – 4.95 GHz (Japan)          • 5.15 – 5.25 GHz          • 5.25 – 5.35 GHz          • 5.47 – 5.725 GHz          • 5.825 – 5.850 GHz</p>
	<p><b>Data Rates</b></p>	<p>• 802.11b: 1, 2, 5.5, 11 Mbps          • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps          • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps          • 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)          • 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, ,80MHz &amp; 160MHz)          • 802.11ax : MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, ,80MHz &amp; 160MHz)</p>
	<p><b>Modulation</b></p>	<p>Direct Sequence Spread Spectrum          OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM</p>
	<p><b>Security<sup>1</sup></b></p>	<p>• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only          • AES-CCMP: 128 bit in hardware          • 802.1x authentication          • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.          • WPA2 certification          • IEEE 802.11i          • WAPI</p>
	<p><b>Network Architecture Models</b></p>	<p>Ad-hoc (Peer to Peer)          Infrastructure (Access Point Required)</p>
	<p><b>Roaming</b></p>	<p>IEEE 802.11 compliant roaming between access points</p>
	<p><b>Output Power<sup>2</sup></b></p>	<p>• 802.11b : +18.5dBm minimum          • 802.11g : +17.5dBm minimum          • 802.11a : +18.5dBm minimum          • 802.11n HT20(2.4GHz) : +15.5dBm minimum          • 802.11n HT40(2.4GHz) : +14.5dBm minimum          • 802.11n HT20(5GHz) : +15.5dBm minimum</p>

### Technical Specifications – Networking

	<ul style="list-style-type: none"> <li>• 802.11n HT40(5GHz) : +14.5dBm minimum</li> <li>• 802.11ac VHT80(5GHz) : +11.5dBm minimum</li> <li>• 802.11ac VHT160(5GHz) : +11.5dBm minimum</li> <li>• 802.11ax HT40(2.4GHz) : +10dBm minimum</li> <li>• 802.11ax VHT160(5GHz) : +10dBm minimum</li> </ul>				
<b>Power Consumption</b>	<ul style="list-style-type: none"> <li>• Transmit mode 2.0 W</li> <li>• Receive mode 1.6 W</li> <li>• Idle mode (PSP) 180 mW (WLAN Associated)</li> <li>• Idle mode 50 mW (WLAN unassociated)</li> <li>• Connected Standby 10mW</li> <li>• Radio disabled 8 mW</li> </ul>				
<b>Power Management</b>	ACPI and PCI Express compliant power management 802.11 compliant power saving mode				
<b>Receiver Sensitivity<sup>3</sup></b>	<ul style="list-style-type: none"> <li>•802.11b, 1Mbps : -93.5dBm maximum</li> <li>•802.11b, 11Mbps : -84dBm maximum</li> <li>• 802.11a/g, 6Mbps : -86dBm maximum</li> <li>• 802.11a/g, 54Mbps : -72dBm maximum</li> <li>• 802.11n, MCS07 : -67dBm maximum</li> <li>• 802.11n, MCS15 : -64dBm maximum</li> <li>• 802.11ac, MCS0 : -84dBm maximum</li> <li>• 802.11ac, MCS9 : -59dBm maximum</li> <li>•802.11ax, MCS11(HT40): -59dBm maximum</li> <li>•802.11ax, MCS11(VHT160): -58.5dBm maximum</li> </ul>				
<b>Antenna Type</b>	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications				
<b>Form Factor</b>	PCI-Express M.2 MiniCard with CNVi Interface				
<b>Dimensions</b>	<ol style="list-style-type: none"> <li>1. Type 2230 : 2.3 x 22.0 x 30.0 mm</li> <li>2. Type 1216: 1.67 x 12.0 x 16.0 mm</li> </ol>				
<b>Weight</b>	<ol style="list-style-type: none"> <li>1. Type 2230 : 2.8g</li> <li>2. Type 126: 1.3g</li> </ol>				
<b>Operating Voltage</b>	3.3v +/- 9%				
<b>Temperature</b>	<table border="0"> <tbody> <tr> <td>Operating</td> <td>14° to 158° F (-10° to 70° C)</td> </tr> <tr> <td>Non-operating</td> <td>-40° to 176° F (-40° to 80° C)</td> </tr> </tbody> </table>	Operating	14° to 158° F (-10° to 70° C)	Non-operating	-40° to 176° F (-40° to 80° C)
Operating	14° to 158° F (-10° to 70° C)				
Non-operating	-40° to 176° F (-40° to 80° C)				
<b>Humidity</b>	<table border="0"> <tbody> <tr> <td>Operating</td> <td>10% to 90% (non-condensing)</td> </tr> <tr> <td>Non-operating</td> <td>5% to 95% (non-condensing)</td> </tr> </tbody> </table>	Operating	10% to 90% (non-condensing)	Non-operating	5% to 95% (non-condensing)
Operating	10% to 90% (non-condensing)				
Non-operating	5% to 95% (non-condensing)				
<b>Altitude</b>	<table border="0"> <tbody> <tr> <td>Operating</td> <td>0 to 10,000 ft (3,048 m)</td> </tr> <tr> <td>Non-operating</td> <td>0 to 50,000 ft (15,240 m)</td> </tr> </tbody> </table>	Operating	0 to 10,000 ft (3,048 m)	Non-operating	0 to 50,000 ft (15,240 m)
Operating	0 to 10,000 ft (3,048 m)				
Non-operating	0 to 50,000 ft (15,240 m)				
<b>LED Activity</b>	LED Amber – Radio Off; LED Off – Radio ON				
<b>HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology</b>					
<b>Frequency Band</b>	2402 to 2480 MHz				
<b>Number of Available Channels</b>	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)				
<b>Data Rates and Throughput</b>	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels				

### Technical Specifications – Networking

	Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
<b>Transmit Power</b>	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.
<b>Power Consumption</b>	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
<b>Bluetooth Software Supported</b>	Microsoft Windows Bluetooth Software
<b>Link Topology</b>	
<b>Power Management</b>	Microsoft Windows ACPI, and USB Bus Support
<b>Certifications</b>	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
<b>Power Management</b>	ETS 300 328, ETS 300 826
<b>Certifications</b>	Low Voltage Directive IEC950 UL, CSA, and CE Mark
<b>Bluetooth Profiles Supported</b>	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)
<b>Security &amp; Manageability</b>	Intel® vPro® support with appropriate Intel® chipset components

**Intel® Wi-Fi 6E AX211 and Bluetooth 5.2 (802.11ax 2 x 2, non-vPro®, supporting gigabit file transfer speeds) nonvPro®**

**Wireless LAN Standards**

- IEEE 802.11a
- IEEE 802.11b
- IEEE 802.11g
- IEEE 802.11n
- IEEE 802.11ac
- IEEE 802.11ax
- IEEE 802.11d
- IEEE 802.11e
- IEEE 802.11h
- IEEE 802.11i
- IEEE 802.11k
- IEEE 802.11r
- IEEE 802.11v

**Interoperability**

Wi-Fi certified

**Frequency Band**

- 802.11b/g/n/ax
- 2.402 – 2.482 GHz
- 802.11a/n/ac/ax



### Technical Specifications – Networking

<b>Data Rates</b>	<ul style="list-style-type: none"><li>• 4.9 – 4.95 GHz (Japan)</li><li>• 5.15 – 5.25 GHz</li><li>• 5.25 – 5.35 GHz</li><li>• 5.47 – 5.725 GHz</li><li>• 5.825 – 5.850 GHz</li><li>• 802.11b: 1, 2, 5.5, 11 Mbps</li><li>• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li><li>• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li><li>• 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)</li><li>• 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, ,80MHz &amp; 160MHz)</li><li>• 802.11ax : MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, ,80MHz &amp; 160MHz)</li></ul>
<b>Modulation</b>	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM , 1024QAM
<b>Security<sup>1</sup></b>	<ul style="list-style-type: none"><li>• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only</li><li>• AES-CCMP: 128 bit in hardware</li><li>• 802.1x authentication</li><li>• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li><li>• WPA2 certification</li><li>• IEEE 802.11i</li><li>• WAPI</li></ul>
<b>Network Architecture Models</b>	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
<b>Roaming</b>	IEEE 802.11 compliant roaming between access points
<b>Output Power<sup>2</sup></b>	<ul style="list-style-type: none"><li>• 802.11b : +18.5dBm minimum</li><li>• 802.11g : +17.5dBm minimum</li><li>• 802.11a : +18.5dBm minimum</li><li>• 802.11n HT20(2.4GHz) : +15.5dBm minimum</li><li>• 802.11n HT40(2.4GHz) : +14.5dBm minimum</li><li>• 802.11n HT20(5GHz) : +15.5dBm minimum</li><li>• 802.11n HT40(5GHz) : +14.5dBm minimum</li><li>• 802.11ac VHT80(5GHz) : +11.5dBm minimum</li><li>• 802.11ac VHT160(5GHz) : +11.5dBm minimum</li><li>• 802.11ax HT40(2.4GHz) : +10dBm minimum</li><li>• 802.11ax VHT160(5GHz) : +10dBm minimum</li></ul>
<b>Power Consumption</b>	<ul style="list-style-type: none"><li>• Transmit mode :2.0 W</li><li>• Receive mode :1.6 W</li><li>• Idle mode (PSP) 180 mW (WLAN Associated)</li><li>• Idle mode :50 mW (WLAN unassociated)</li><li>• Connected Standby/Modern Standby: 10mW</li><li>• Radio disabled: 8 mW</li></ul>
<b>Power Management</b>	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
<b>Receiver Sensitivity<sup>3</sup></b>	<ul style="list-style-type: none"><li>• 802.11b, 1Mbps : -93.5dBm maximum</li><li>• 802.11b, 11Mbps : -84dBm maximum</li><li>• 802.11a/g, 6Mbps : -86dBm maximum</li><li>• 802.11a/g, 54Mbps : -72dBm maximum</li><li>• 802.11n, MCS07 : -67dBm maximum</li><li>• 802.11n, MCS15 : -64dBm maximum</li><li>• 802.11ac, MCS0 : -84dBm maximum</li></ul>

### Technical Specifications – Networking

<b>Antenna Type</b>	<ul style="list-style-type: none"> <li>• 802.11ac, MCS9 : -59dBm maximum</li> <li>• 802.11ax, MCS11 (HT40): -59dBm maximum</li> <li>• 802.11ax, MCS11 (VHT160): -58.5dBm maximum</li> </ul> <p>High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications</p>				
<b>Form Factor</b>	PCI-Express M.2 MiniCard with CNVi Interface				
<b>Dimensions</b>	<p>1. Type 2230 : 2.3 x 22.0 x 30.0 mm</p> <p>2. Type 1216: 1.67 x 12.0 x 16.0 mm</p>				
<b>Weight</b>	<p>1. Type 2230 : 2.8g</p> <p>2. Type 126: 1.3g</p>				
<b>Operating Voltage</b>	3.3v +/- 9%				
<b>Temperature</b>	<table border="0"> <tr> <td>Operating</td> <td>14° to 158° F (-10° to 70° C)</td> </tr> <tr> <td>Non-operating</td> <td>-40° to 176° F (-40° to 80° C)</td> </tr> </table>	Operating	14° to 158° F (-10° to 70° C)	Non-operating	-40° to 176° F (-40° to 80° C)
Operating	14° to 158° F (-10° to 70° C)				
Non-operating	-40° to 176° F (-40° to 80° C)				
<b>Humidity</b>	<table border="0"> <tr> <td>Operating</td> <td>10% to 90% (non-condensing)</td> </tr> <tr> <td>Non-operating</td> <td>5% to 95% (non-condensing)</td> </tr> </table>	Operating	10% to 90% (non-condensing)	Non-operating	5% to 95% (non-condensing)
Operating	10% to 90% (non-condensing)				
Non-operating	5% to 95% (non-condensing)				
<b>Altitude</b>	<table border="0"> <tr> <td>Operating</td> <td>0 to 10,000 ft (3,048 m)</td> </tr> <tr> <td>Non-operating</td> <td>0 to 50,000 ft (15,240 m)</td> </tr> </table>	Operating	0 to 10,000 ft (3,048 m)	Non-operating	0 to 50,000 ft (15,240 m)
Operating	0 to 10,000 ft (3,048 m)				
Non-operating	0 to 50,000 ft (15,240 m)				
<b>LED Activity</b>	LED Amber – Radio OFF; LED White – Radio ON				
<b>HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology</b>					
<b>Frequency Band</b>	2402 to 2480 MHz				
<b>Number of Available Channels</b>	<p>Legacy : 0~79 (1 MHz/CH)</p> <p>BLE : 0~39 (2 MHz/CH)</p>				
<b>Data Rates and Throughput</b>	<p>Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps</p> <p>BLE : 1 Mbps data rate; throughput up to 0.2 Mbps</p> <p>Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels</p> <p>Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)</p>				
<b>Transmit Power</b>	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.				
<b>Power Consumption</b>	<p>Peak (Tx): 330 mW</p> <p>Peak (Rx): 230 mW</p> <p>Selective Suspend: 17 mW</p>				
<b>Bluetooth Software Supported</b>	Microsoft Windows Bluetooth Software				
<b>Link Topology</b>					
<b>Power Management</b>	Microsoft Windows ACPI, and USB Bus Support				
<b>Certifications</b>	FCC (47 CFR) Part 15C, Section 15.247 & 15.249				
<b>Power Management Certifications</b>	<p>ETS 300 328, ETS 300 826</p> <p>Low Voltage Directive IEC950</p> <p>UL, CSA, and CE Mark</p>				
<b>Bluetooth Profiles Supported</b>	<p>BT4.1-ESR 5/6/7 Compliance</p> <p>LE Link Layer Ping</p> <p>LE Dual Mode</p>				

### Technical Specifications – Networking

- LE Link Layer
- LE Low Duty Cycle Directed Advertising
- LE L2CAP Connection Oriented Channels
- Train Nudging & Interlaced Scan
- BT4.2 ESR08 Compliance
- LE Secure Connection- Basic/Full
- LE Privacy 1.2 –Link Layer Privacy
- LE Privacy 1.2 –Extended Scanner Filter Policies
- LE Data Packet Length Extension
- FAX Profile (FAX)
- Basic Imaging Profile (BIP)2
- Headset Profile (HSP)
- Hands Free Profile (HFP)
- Advanced Audio Distribution Profile (A2DP)

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### Technical Specifications – Power

#### POWER

<b>200 Watt Smart Slim AC Adapter</b>	<b>Dimensions</b>	152x73x23.5mm	
	<b>Weight</b>	unit: 530g +/- 10g	
	<b>Input</b>	<b>Input Efficiency</b>	88% at 115 Vac and 89% at 230Vac
		<b>Input frequency range</b>	47 ~ 63 Hz
		<b>Input AC current</b>	2.9 A at 90 Vac and Maximum Load
	<b>Output</b>	<b>Output power</b>	200W
		<b>DC output</b>	19.5V
		<b>Hold-up time</b>	5ms at 115 Vac input
		<b>Output current limit</b>	<16.0A
	<b>Connector</b>	4.5mm Barrel Type	
	<b>Environmental Design</b>	<b>Operating temperature</b>	32° to 95° F (0° to 35° C)
		<b>Non-operating (storage) temperature</b>	-4° to 185° F (-20° to 85° C)
		<b>Altitude</b>	0 to 16,400 ft (0 to 5,000 m)
		<b>Humidity</b>	5% to 95%
		<b>Storage Humidity</b>	5% to 95%
<b>EMI and Safety Certifications</b>	Eg: *CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.		

<b>HP 6-cell Long Life Li-Ion (83 WHr)</b>	<b>Dimensions (H x W x L)</b>	7.78x71.05x316.1 mm (0.306 x 2.797 x 12.44 inch)		
	<b>Weight</b>	0.305kg(0.67lb)		
	<b>Cells/Type</b>	3cell Lithium-Ion Polymer cell		
	<b>Energy</b>	<b>Voltage</b>	11.58V	
		<b>Amp-hour capacity</b>	7.17Ah / 6.88Ah	
		<b>Watt-hour capacity</b>	83Wh	
	<b>Temperature</b>	<b>Operating (Charging)</b>	32° to 113° F (0° to 45° C)	
		<b>Operating (Discharging)</b>	14° to 122° F (-10° to 60° C)	
	<b>Fuel Gauge LED</b>	NA		
	<b>Warranty</b>	1-year[6]		
<b>Optional Travel Battery Available</b>	No			

### Technical Specifications – Environmental

#### ENVIRONMENTAL DATA

##### Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT® Gold registered in the United States. See <http://www.epeat.net> for registration status in your country.

##### System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a “Typically Configured Notebook”.

##### Energy Consumption (in accordance with US ENERGY STAR® test method)

	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	9.62 W	10.54 W	9.37 W
Normal Operation (Long idle)	0.95 W	1.07 W	0.98 W
Sleep	0.95 W	1.07 W	0.98 W
Off	0.36 W	0.47 W	0.34 W

##### NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

##### Heat Dissipation\*

	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	32.9004 BTU/hr	36.0468 BTU/hr	32.0454 BTU/hr
Normal Operation (Long idle)	3.249 BTU/hr	3.6594 BTU/hr	3.3516 BTU/hr
Sleep	3.249 BTU/hr	3.6594 BTU/hr	3.3516 BTU/hr
Off	1.2312 BTU/hr	1.6074 BTU/hr	1.1628 BTU/hr

**\*NOTE:** Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

##### Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

	Sound Power (L <sub>WAd</sub> , bels)	Sound Pressure (L <sub>pAm</sub> , decibels)
Typically Configured – Idle	2.5	22
Fixed Disk – Random writes	3.6	35.5

##### Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 1 M.2 2280 PCIe Gen 3 x 4 NVMe Solid State Drive Slot (does not support SATA M.2 2280 drives)

Spare parts are available throughout the warranty period and or for up to “5” years after the end of production.

##### Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

### Technical Specifications – Environmental

Batteries used in the product do not contain:  
 Mercury greater than 1ppm by weight  
 Cadmium greater than 20ppm by weight

Battery description: CR2032 (coin cell)  
 Battery type: Lithium

#### Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the gold level, see [www.epeat.net](http://www.epeat.net)
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 7.8% post-consumer recycled plastic (by wt.)
- This product is 96.1% recycle-able when properly disposed of at end of life.

#### Packaging Materials

<b>External:</b>	PAPER/Corrugated	1292 g
	PAPER/Paper	20 g
	PAPER/Molded pulp	307 g
<b>Internal:</b>	PLASTIC/Polyethylene low density - LDPE	10 g
	PLASTIC/Polyester	10 g
	PLASTIC/Polypropylene - PP	7 g

The plastic packaging material contains at least 50% recycled content.

The corrugated paper packaging materials contains at least 70% recycled content.

#### Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at <http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf>):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants – may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)

### Technical Specifications – Environmental

- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) – except for wires and cables, has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

#### Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

#### End-of-life Management and Recycling

HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <http://www.hp.com/go/reuse-recycle> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the HP web site at: <http://www.hp.com/go/recyclers>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

#### HP Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

<http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html>

Eco-label certifications

<http://www8.hp.com/us/en/hp-information/environment/ecolabels.html>

ISO 14001 certificates:

<http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842>

and

<http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf>

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<b>Date of change:</b>	<b>Version History:</b>		<b>Description of change:</b>
September 28, 2020	From v1 to v2	Changed	WEIGHTS & DIMENSIONS section
October 1, 2020	From v2 to v3	Changed	At A Glance, STORAGE AND DRIVES and SOFTWARE AND SECURITY sections
November 18, 2020	From v3 to v4	Changed	At A Glance, OPERATING SYSTEM, GRAPHICS, STORAGE AND DRIVES, PORTS/SLOTS sections
December 16, 2020	From v4 to v5	Added	BIOS Version in Software and Security section
April 22, 2021	From v5 to v6	Changed	INTEL CORE I5 WITH VPRO/CORE I7 WITH VPRO TECHNOLOGY CAPABLE and NETWORKING/COMMUNICATIONS sections
May 11, 2021	From v6 to v7	Changed	WEIGHTS & DIMENSIONS section
May 20, 2021	From v7 to v8	Changed	Graphics and SOFTWARE AND SECURITY sections
May 31, 2021	From v8 to v9	Added	HP Smart Support and footnote
June 16, 2021	From v9 to v10	Changed	SYSTEM UNIT Temperature section
July 22, 2021	From v10 to v11	Removed	HDR400 and True Black references
August 11, 2021	From v11 to v12	Changed	WEIGHTS & DIMENSIONS section